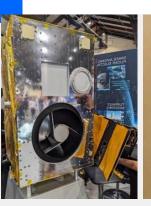
# eTAP Universal Attachment

Attach to any space surface with Cambrian Works' electric Thin Attachment Pad (eTAP) subsystem.







### **Universal Compatibility**

Adheres to virtually any space material--conductors, insulators, and dielectrics. No ferrous materials or surface preparation required.

#### **Ultra-Low Power**

Consumes 90% less power than electromagnetic alternatives.

#### **Space-Ready Design**

Built with space-rated materials, engineered for the harsh orbital environment.

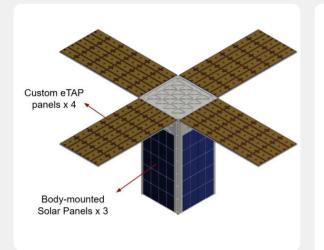
#### Infinitely Reusable

Zero degradation over 1,000 attachment/detachment test cycles. No residue, consumables, or mechanical wear.

#### **Mission Applications**

- Payload Augmentations
- Satellite Servicina
- Debris Removal
- Robotic Operations
- In-Space Assembly
- Refueling Misions
- Detumbling Operations







Attach and manipulate in ways that seem natural, without required

preparation or training.

Attachment Force

#### >8N (scalable with multiple pads)

Response Time:

<100ms activation

Operating Power

<250mW at 5VDC

Pad Thickness

<0.1 mm ultra-thin profile

Platform Compatibility

1U CubeSat to ESPA-class

Control Interface

USB, RS-485, or direct I/O

Capture Velocity

Tested Up to 10 cm/s

Angular Capability

±5° off-normal approach

## **Compatible Materials:**

- Al Alloys
- Glass & ITO
- Anondized Al
- Kapton
- Steel
- MLI
- Titanium
- Carbon Fiber

And More!

# Universal Space Attachment